PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|----------------|--|
| 1.1 Company | Life.augmented | STMicroelectronics International N.V |
| 1.2 PCN No. | | ADG/23/14402 |
| 1.3 Title of PCN | | STL130N8F7 / STL13080 (OD88): Metal and Passivation Change |
| 1.4 Product Category | | STL130N8F7 / STL13080 |
| 1.5 Issue date | | 2023-11-10 |

| 2. PCN Team | | |
|---------------------------|--------------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | NEMETH KRISZTINA | |
| 2.1.2 Phone | +49 89460062210 | |
| 2.1.3 Email | krisztina.nemeth@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Mario ASTUTI | |
| 2.1.2 Marketing Manager | Anna RANIOLO,Martina GIUFFRIDA | |
| 2.1.3 Quality Manager | Diego Maria FERRARI | |

| 3. Change | | |
|--------------|--|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Metallization : change in metal layers type/nature, composition or final thickness | ST AngMoKio (Singapore) |

| 4. Description of change | | | |
|---|--|--|--|
| | Old New | | |
| 4.1 Description | Metal: TiAlCu 4.5 um Passivation: TEOS 10 kA + Sin 10kA | Metal: TiAlCu 3.2 um Passivation: USG 6 kA + TEOS 12 kA | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact | | |

| 5. Reason / motivation for change | |
|-----------------------------------|-----------------------------|
| 5.1 Motivation | Fab Process Rationalization |
| 5.2 Customer Benefit | SERVICE CONTINUITY |

| 6. Marking of parts / traceability of change | | |
|--|-------------------------------|--|
| 6.1 Description | Dedicated Finished Good Codes | |
| | | |

| 7. Timing / schedule | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2023-11-07 |
| 7.2 Intended start of delivery | 2024-02-29 |
| 7.3 Qualification sample available? | Upon Request |

| 8. Qualification / Validation | | | |
|---|----------------------------|---------------|------------|
| 8.1 Description 14402 RERLVIP23041_1.0_STL130N8F7_OD88_SG8_STS_PFLAT5x6.pdf | | | |
| 8.2 Qualification report and qualification results | Available (see attachment) | Issue Date | 2023-11-10 |

9. Attachments (additional documentations)

14402 Public product.pdf 14402 detail.pdf 14402 RERLVIP23041_1.0_STL130N8F7_OD88_SG8_STS_PFLAT5x6.pdf

| 10. Affected parts | | | |
|---|------------|--------------------------|--|
| 10. 1 Current | | 10.2 New (if applicable) | |
| 10.1.1 Customer Part No 10.1.2 Supplier Part No | | 10.1.2 Supplier Part No | |
| | STL130N8F7 | | |

IMPORTANT NOTICE - PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics - All rights reserved